

General Description

The MAX4102/MAX4103 op amps combine high-speed performance and ultra-low differential gain and phase while drawing only 5mA of supply current. The MAX4102 is compensated for unity-gain stability, while the MAX4103 is compensated for a closed-loop gain (A_{VCL}) of 2V/V or greater.

The MAX4102/MAX4103 deliver a 250MHz -3dB bandwidth (MAX4102) or a 180MHz -3dB bandwidth (MAX4103). Differential gain and phase are an ultra-low 0.002%/0.002° (MAX4102) and 0.008%/0.003° (MAX4103), making these amplifiers ideal for composite video applications.

These high-speed op amps have a wide output voltage swing of $\pm 3.4 \text{V}$ (R_L = 100 Ω) and 80mA current-drive capability.

Applications

Broadcast and High-Definition TV Systems

Pulse/RF Amplifier

ADC/DAC Amplifier

Features

- ♦ 250MHz -3dB Bandwidth (MAX4102) 180MHz -3dB Bandwidth (MAX4103)
- ♦ Unity-Gain Stable (MAX4102)
- ♦ 350V/µs Slew Rate
- ♦ Lowest Differential Gain/Phase ($R_L = 150\Omega$)

MAX4102: 0.002%/0.002° MAX4103: 0.008%/0.003°

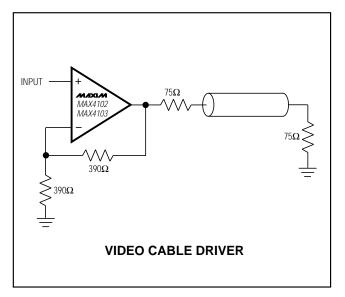
- ♦ Low Distortion (SFDR 5MHz): -78dBc
- ♦ 100dB Open-Loop Gain
- ♦ High Output Drive: 80mA
- ♦ Low Power: 5mA Supply Current

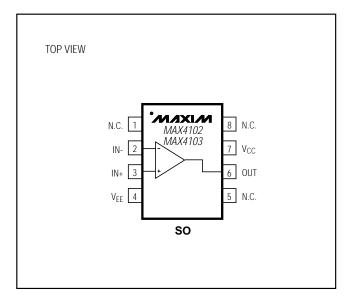
Ordering Information

Pin Configuration

PART	TEMP. RANGE	PIN-PACKAGE		
MAX4102ESA	-40°C to +85°C	8 SO		
MAX4103ESA	-40°C to +85°C	8 SO		

Typical Application Circuit





/VIXI/VI

Maxim Integrated Products 1

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ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V _{CC} to V _{EE})	12V
Voltage on Any Pin to Ground or Any Other Pin	
Short-Circuit Duration (Vout to GND)	.Continuous
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
SO (derate 5.88mW/°C above ± 70 °C)	471m\//

Operating Temperature Range	
MAX4102ESA/MAX4103ESA	40°C to +85°C
Storage Temperature Range	65°C to +160°C
Lead Temperature (soldering,	10sec)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 5V, V_{EE} = -5V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DC SPECIFICATIONS			1				
Input Offset Voltage	Vos	V _{OUT} = 0V			0.5	8	mV
Input Offset Voltage Drift	TCVos	V _{OUT} = 0V			5		μV/°C
Input Bias Current	ΙΒ	V _{OUT} = 0V, V _{IN} = -V _{OS}			3	9	μΑ
Input Offset Current	los	V _{OUT} = 0V, V _{IN} = -V _{OS}			0.04	0.5	μΑ
Common-Mode Input Resistance	RINCM	Either input			5		MΩ
Common-Mode Input Capacitance	CINCM	Either input			1		рF
Innut Valtage Naige		f = 100kHz	MAX4102		7		nV/√ Hz
Input Voltage Noise	en	I = IUUKHZ	MAX4103		5		
Integrated Valtage Naice		f = 1MHz to 100MHz	MAX4102		88		μV _{RMS}
Integrated Voltage Noise			MAX4103		63		
Innut Current Noice	in	f = 100kHz	MAX4102		1.0		pA/√Hz
Input Current Noise			MAX4103		1.0		
Integrated Current Naice		f = 1MHz to 100MHz	MAX4102		12.5		- nA _{RMS}
Integrated Current Noise		I = IIVIMZ (O TOUIVIMZ	MAX4103		12.5		
Common-Mode Input Voltage	V _{CM}		,	-2.5		2.5	V
Common-Mode Rejection	CMR	$V_{CM} = \pm 2.5V$		75	100		dB
Power-Supply Rejection	PSR	$V_S = \pm 4.5 V \text{ to } \pm 5.5 V$		70	100		dB
Open Lean Voltage Cain	Avol	V2 OV V OV	R _L = ∞	66	96		- dB
Open-Loop Voltage Gain		$V_{OUT} = \pm 2.0V, V_{CM} = 0V$ $R_{L} = 100\Omega$		70	100		l ub
Quiescent Supply Current	I _{SY}	V _{IN} = 0V			4.6	6	mA
Output Voltage Swing		R _L = ∞		±3.3	±3.7		- V
Output Voltage Swing	Vout	$R_L = 100\Omega$		±3.1	±3.4		
Output Current		$R_L = 30\Omega$, $T_A = 0^{\circ}C$ to $+85^{\circ}C$		65	80		mA
Short-Circuit Output Current	I _{SC}	Short to ground or either supply voltage			90		mA

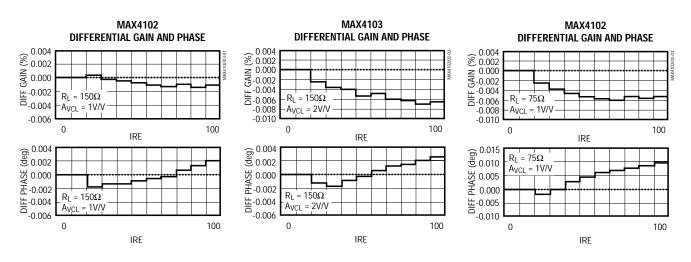
AC ELECTRICAL CHARACTERISTICS

 $(V_{CC}=5V,V_{EE}=-5V,R_L=100\Omega,A_{VCL}=+1$ (MAX4102), $A_{VCL}=+2$ (MAX4103), $T_A=+25^{\circ}C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
AC SPECIFICATIONS		I				-		·II
-3dB Bandwidth	BW	V _{OUT} ≤ 0.1V _{RMS} MAX4102 MAX4103		MAX4102		250		MHz
-3UD Daliuwiuili	DVV				180		IVITIZ	
0.1dB Bandwidth		MAX4102		130 80		MHz		
U. TUB Balluwidili		MAX4103						
Slew Rate	SR	-2V ≤ V _{OUT} ≤ 2V			350		V/µs	
Cottling Time	+	-1V ≤ V _{OUT} ≤ 1V		to 0.1%		18		ns
Settling Time	t _S			to 0.01%		30		
Rise/Fall Times	to to	10% to 90%, -2V ≤ V _{OUT} ≤ 2V			13		ns	
RISE/Fall Tillies	t _R , t _F	10% to 90%, -50mV ≤ V _{OUT} ≤ 50mV			1.5			
DISC. III I O I	DG	f = 3.58MHz,	MAX4102			0.002		- %
Differential Gain	l DG	$R_L = 150\Omega$	MAX4103			0.008		7 %
Differential Phase	DP	f = 3.58MHz,	MAX4102			0.002		dograce
Differential Phase	DP	$R_L = 150\Omega$ MAX			0.003		degrees	
Input Capacitance	CIN	'				2		pF
Output Resistance	Dave	f 10MHz	MAX4102			0.7		Ω
	Rout	f = 10MHz MAX4103				0.7		7 22
Country Francis Description	CEDD					-78		dDo
Spurious-Free Dynamic Range	SFDR					-76		– dBc

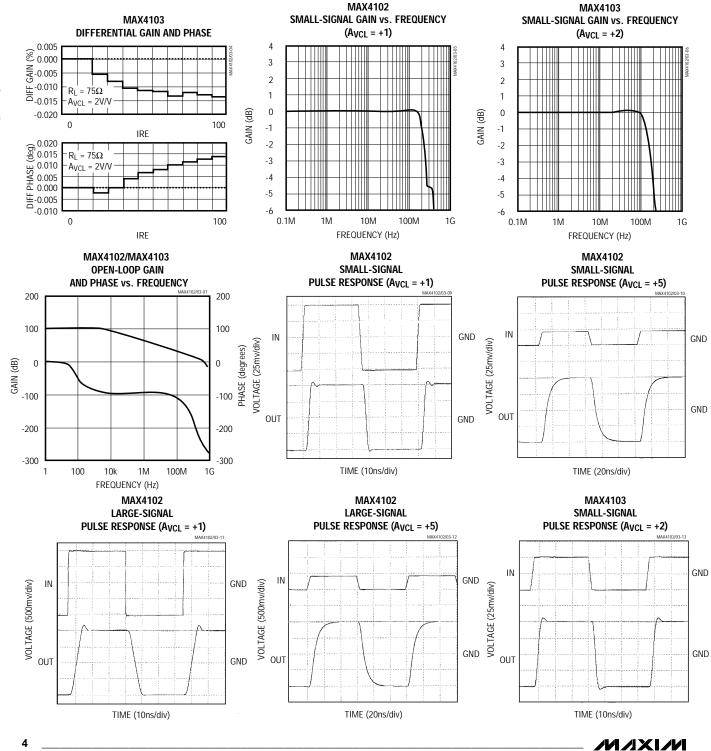
_Typical Operating Characteristics

 $(V_{CC} = 5V, V_{EE} = -5V, R_L = 100\Omega, T_A = +25$ °C, unless otherwise noted.)



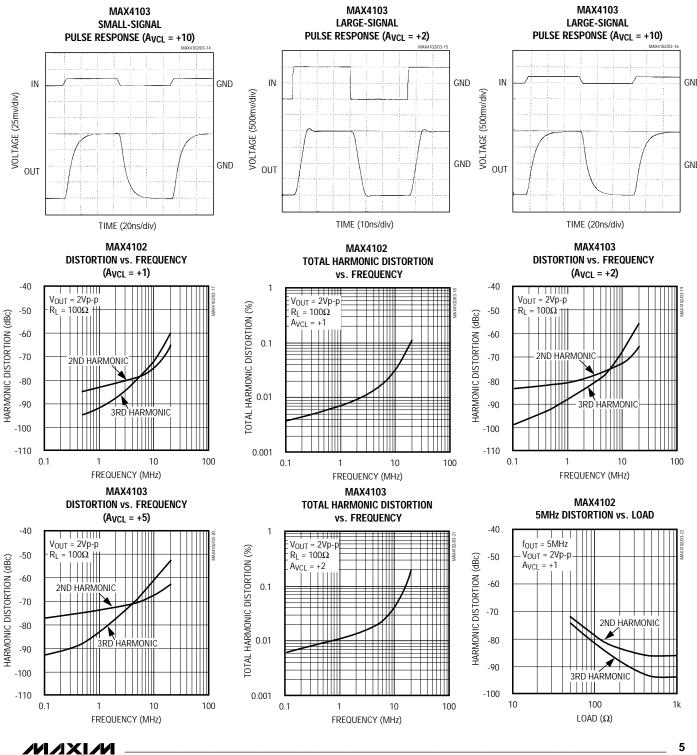
Typical Operating Characteristics (continued)





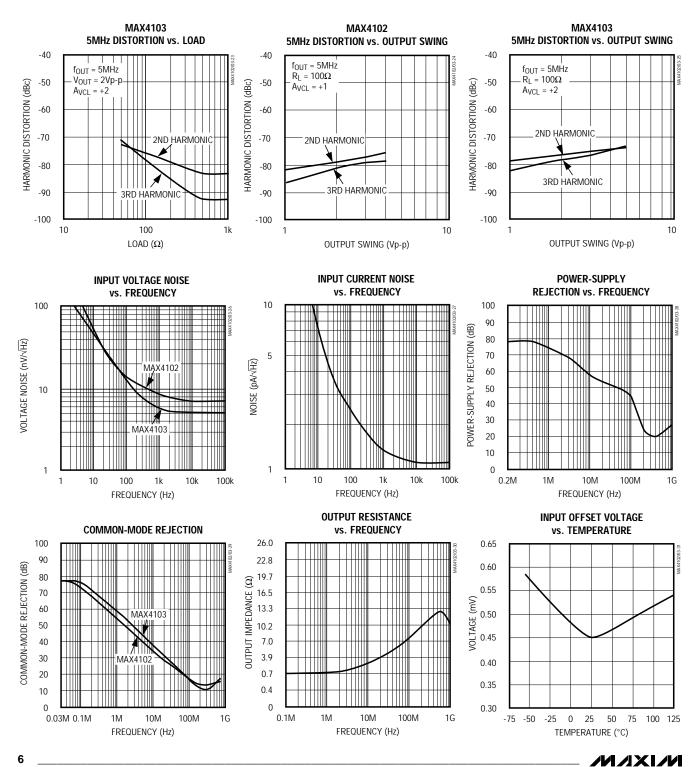
Typical Operating Characteristics (continued)

 $(V_{CC} = 5V, V_{EE} = -5V, R_L = 100\Omega, T_A = +25^{\circ}C, unless otherwise noted.)$



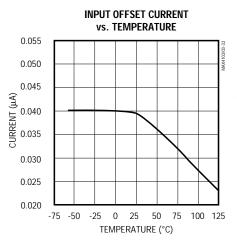
Typical Operating Characteristics (continued)

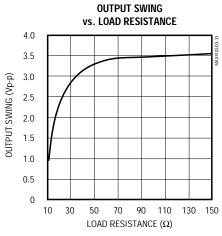
 $(V_{CC} = 5V, V_{EE} = -5V, R_L = 100\Omega, T_A = +25^{\circ}C, unless otherwise noted.)$

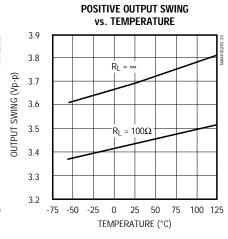


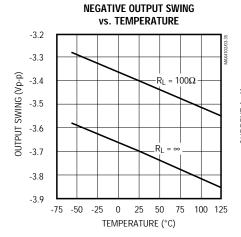
Typical Operating Characteristics (continued)

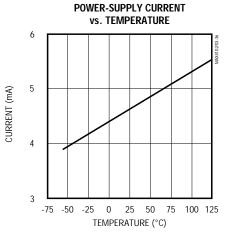
 $(V_{CC} = 5V, V_{EE} = -5V, R_L = 100\Omega, T_A = +25^{\circ}C, unless otherwise noted.)$

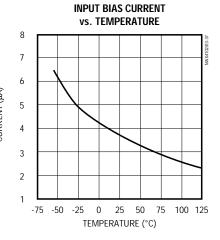












Pin Description

PIN	NAME	FUNCTION
1	N.C.	Not internally connected
2	IN-	Inverting Input
3	IN+	Noninverting Input
4	V _{EE}	Negative Power Supply. Connect to -5V
5	N.C.	Not internally connected
6	OUT	Amplifier Output
7	Vcc	Positive Power Supply. Connect to +5V
8	N.C.	Not internally connected

Detailed Description

The MAX4102/MAX4103 low-power, high-speed op amps feature ultra-low differential gain and phase, and are optimized for the highest quality video applications. Differential gain and phase errors are 0.002%/0.002° for the MAX4102 and 0.008%/0.003° for the MAX4103. The MAX4102 also features a -3dB bandwidth of over 250MHz and 0.1dB gain-flatness of 130MHz. The MAX4103 features a -3dB bandwidth of 180MHz and a 0.1dB bandwidth of 80MHz.

The MAX4102 is unity-gain stable, and the MAX4103 is optimized for closed-loop gains of 2V/V (6dB) and higher. Both devices drive back-terminated 50Ω or 75Ω cables to $\pm 3.1V$ (min) and deliver an output current of 80mA.

Available in a small 8-pin SO package, the MAX4102/MAX4103 are ideal for high-definition TV systems (in RGB, broadcast, or consumer video applications) that benefit from low power consumption and superior differential gain and phase characteristics.

_Applications Information Grounding, Bypassing, and PC Board Layout

In order to achieve the full bandwidth, Microstrip and Stripline techniques are recommended in most cases. To ensure your PC board does not degrade the amp's performance, it's wise to design the board for a frequency greater than 1GHz. Even with very short runs, it's good practice to use this technique at critical points, such as inputs and outputs. Whether you use a constant-impedance board or not, observe the following guidelines when designing the board:

- Do not use wire-wrap boards, because they are too inductive.
- Do not use IC sockets. They increase parasitic capacitance and inductance.
- In general, surface-mount components have shorter leads and lower parasitic reactance, and give better high-frequency performance than through-hole components.
- The PC board should have at least two layers, with one side a signal layer and the other a ground plane.
- Keep signal lines as short and as straight as possible. Do not make 90° turns; round all corners.
- The ground plane should be as free from voids as possible.

On Maxim's evaluation kit, the ground plane has been removed from areas where keeping the trace capacitance to a minimum is more important than maintaining ground continuity. For example, the ground plane has been removed from beneath the IC to minimize pin capacitance.

The bypass capacitors should include a $0.1\mu F$ at each supply pin and the ground plane, located as close to the package as possible. Then place a $10\mu F$ to $15\mu F$ low-ESR tantalum at the point of entry (to the PC board) of the power-supply pins. The power-supply trace should lead directly from the tantalum capacitor to the V_{CC} and V_{EE} pins to maintain the low differential gain and phase of these devices.

Setting Gain

The MAX4102/MAX4103 are voltage-feedback op amps that can be configured as an inverting or noninverting gain block, as shown in Figures 1a and 1b. The gain is determined by the ratio of two resistors and does not affect amplifier frequency compensation.

In the unity-gain configuration (Figure 1c), maximum bandwidth and stability are achieved with the MAX4102 when a small feedback resistor is included. This resistor suppresses the negative effects of parasitic inductance and capacitance. A value of 24Ω provides the best combination of wide bandwidth, low peaking, and fast settling time. In addition, this resistor reduces the errors from input bias currents.

Choosing Resistor Values

The values of feedback and input resistors used in the inverting or noninverting gain configurations are not critical (as is the case with current-feedback amplifiers), but should be kept small and noninductive.

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The input capacitance of the MAX4102/MAX4103 is approximately 2pF. In either the inverting or noninverting configuration, the bandwidth limit caused by the package capacitance and resistor time constant is f3dB = 1 / (2 Π RC), where R is the parallel combination of the input and feedback resistors (RF and RG in Figure 2) and C is the package and board capacitance at the inverting input. RS1 and RS2 represent the input termination resistors. Table 1 shows the typical bandwidth and resistor values for several gain configurations.

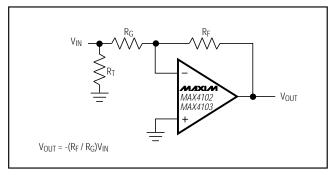


Figure 1a. Inverting Gain Configuration

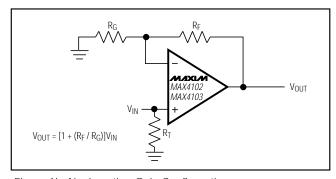


Figure 1b. Noninverting Gain Configuration

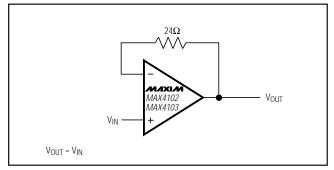


Figure 1c. MAX4102 Unity-Gain Buffer Configuration

Table 1. Resistor and Bandwidth Values for Various Gain Configurations

DEVICE	GAIN (V/V)	R _G (Ω)	R _F (Ω)	R τ (Ω)	BAND- WIDTH (MHz)
MAX4102	1	∞	24	50	250
MAX4102	2	200	200	50	100
MAX4103	2	200	200	50	180
MAX4103	5	50	200	50	40
MAX4103	10	30	270	50	20
MAX4103	-1	200	200	56	180
MAX4103	-2	75	150	150	140
MAX4103	-5	50	250	∞	75
MAX4103	-10	50	500	∞	35

Note: Refer to Figure 1a for inverting gain configurations and Figure 1b for noninverting gain configurations. R_T is calculated for 50Ω systems.

Resistor Types

Surface-mount resistors are the best choice for high-frequency circuits. They are of similar material to the metal-film resistors, but are deposited using a thick-film process in a flat, linear manner so that inductance is minimized. Their small size and lack of leads also minimize parasitic inductance and capacitance, thereby yielding more predictable performance.

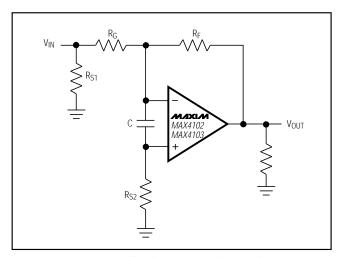


Figure 2. Effect of Feedback Resistor Values and Parasitic Capacitance on Bandwidth



Driving Capacitive Loads

When driving 50Ω or 75Ω back-terminated transmission lines, capacitive loading is not an issue. The MAX4102/MAX4103 can typically drive 5pF and 20pF, respectively. Figure 3a illustrates how a capacitive load influences the amplifier's peaking without an isolation resistor (Rs). Figure 3b shows how an isolation resistor decreases the amplifier's peaking. By using a small isolation resistor

between the amplifier output and the load, large capacitance values may be driven without oscillation (Figure 4a). In most cases, less than 50Ω is sufficient. Use Figure 4b to determine the value needed in your application. Determine the worst-case maximum capacitive load you may encounter and select the appropriate resistor from the graph.

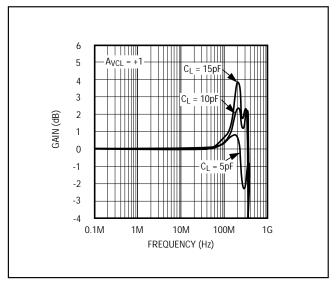


Figure 3a. MAX4102 Bandwidth vs. Capacitive Load (No Isolation Resistor (R_S))

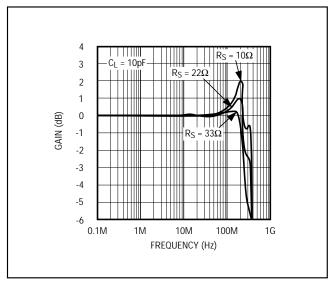


Figure 3b. MAX4102 Bandwidth vs. 10pF Capacitive Load and Isolation Resistor

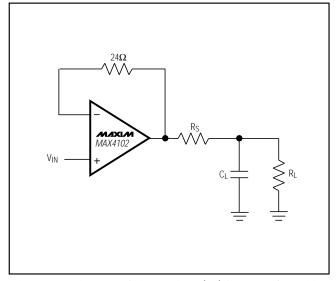


Figure 4a. Using an Isolation Resistor (R_S) for Large Capacitive Loads (MAX4102)

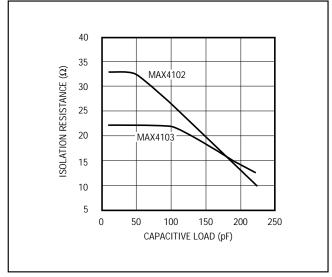
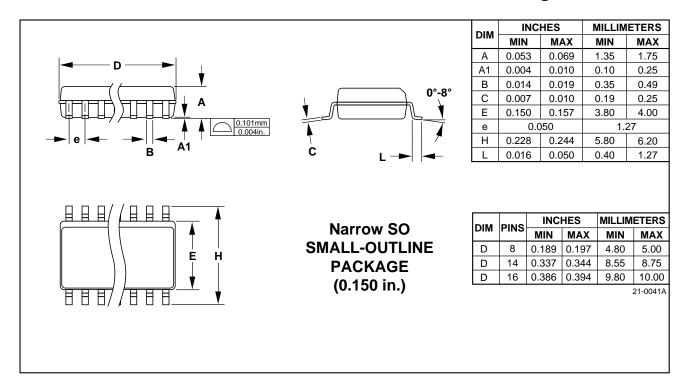


Figure 4b. Isolation vs. Capacitive Load

Package Information



_Chip Information

TRANSISTOR COUNT: 51

SUBSTRATE CONNECTED TO: VEE

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